

DUAL P-CHANNEL 60V ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} Max	I _D T _A = +25°C (Notes 4 & 6)
601/	85mΩ @ V _{GS} = -10V	-3.9A
-60V	125mΩ @ V _{GS} = -4.5V	-3.2A

Description

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

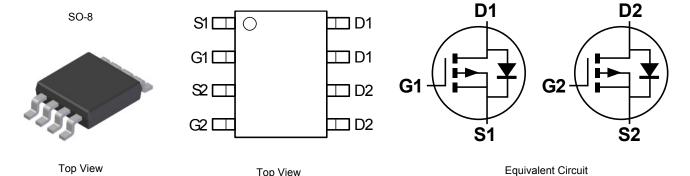
- DC-DC Converters
- Power Management Functions
- Disconnect Switches
- Motor Control

Features

- Low On-Resistance
- Fast Switching Speed
- Low Threshold
- Low Gate Drive
- Low Profile SOIC Package
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Available

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.074 grams (approximate)



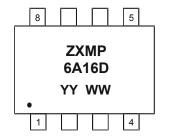
Ordering Information

Part Number	Qualification	Case	Packaging
ZXMP6A16DN8QTA	Automotive	SO-8	500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_grade_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



ZXMP6A16D = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 11 = 2011) WW = Week (01 - 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source voltage			V _{DSS}	-60	V
Gate-Source voltage		(Note 6)	V _{GS}	±20	V
		(Notes 8 & 10)		-3.9	
Continuous Drain current	$V_{GS} = 10V$	T _A = +70°C (Notes 8 & 10)	I _D	-3.1	Α
		(Notes 7 & 10)		-2.9	
Pulsed Drain current		(Notes 9 & 10)	I _{DM}	-18.3	Α
Continuous Source current (Body diode)		(Notes 8 & 10)	I _S	-3.2	Α
Pulsed Source current (Body diode) (Note		(Notes 9 & 10)	I _{SM}	-18.3	Α

Thermal Characteristics

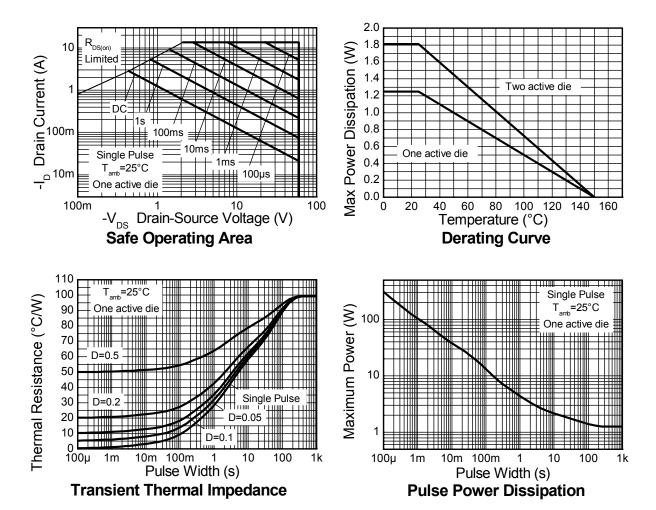
Characteristic	Symbol	Value	Unit		
	(Notes 7 & 10)		1.25 10.0		
Power dissipation Linear derating factor	(Notes 7 & 11)	P _D	1.81 14.5	W mW/°C	
	(Notes 8 & 10)		2.15 17]	
	(Notes 7 & 10)		100		
Thermal Resistance, Junction to Ambient	(Notes 7 & 11)	$R_{\theta JA}$	70	9C/M/	
	(Notes 8 & 10)		60	°C/W	
Thermal Resistance, Junction to Lead	(Notes 10 & 12)	R _{0JL}	48.85		
Operating and storage temperature range	T _J , T _{STG}	-55 to +150	°C		

Notes:

- 6. AEC-Q101 V_{GS} maximum is $\pm 16 \text{V}.$
- 7. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 8. Same as note (7), except the device is measured at $t \le 10$ sec.
- Same as note (7), except the device is pulsed with D = 0.02 and pulse width 300μs.
 For a dual device with one active die.
- For a device with two active die running at equal power.
 Thermal resistance from junction to solder-point.



Thermal Characteristics





Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

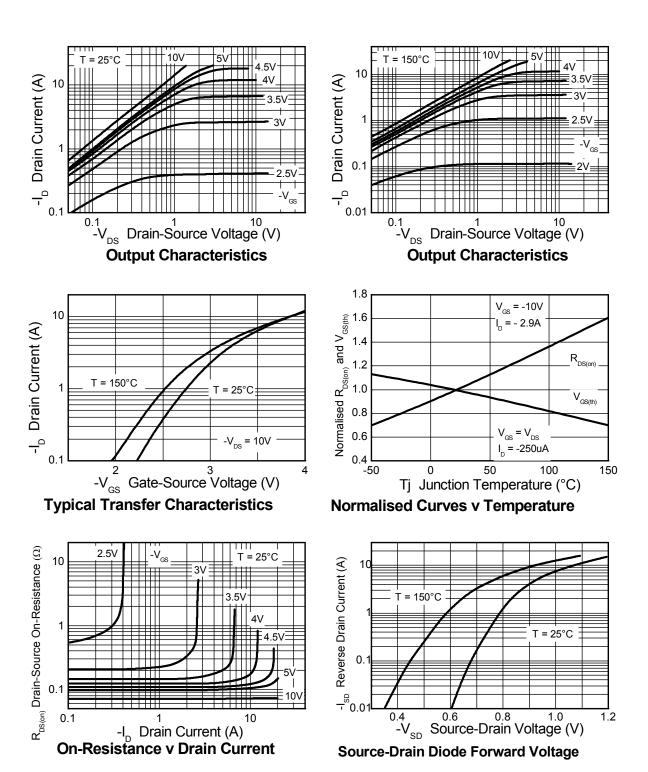
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		-60	_	_	V	$I_D = -250 \mu A, V_{GS} = 0V$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1.0	μA	V _{DS} = -60V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V _{GS} = ±20V, V _{DS} = 0V	
ON CHARACTERISTICS	0 000 7 20						
Gate Threshold Voltage	$V_{GS(th)}$	-1	_	_	V	$I_D = -250 \mu A, V_{DS} = V_{GS}$	
Chatia Duain Course On Desistance (Nate 42)			_	85	0	V _{GS} = -10V, I _D = -2.9A	
Static Drain-Source On-Resistance (Note 13)	R _{DS} (ON)	_	_	125	mΩ	$V_{GS} = -4.5V, I_D = -2.4A$	
Forward Transconductance (Notes 13 & 14)	9 _{fs}	_	7.2	_	S	V _{DS} = -15V, I _D = -2.9A	
Diode Forward Voltage (Note 13)	V_{SD}	_	-0.85	-0.95	V	I _S = -3.4A, V _{GS} = 0V, T _J = +25°C	
Reverse recovery time (Note 14)		_	29.2	_	ns	$I_S = -2A$, di/dt = 100A/ μ s,	
Reverse recovery charge (Note 14)	Q _{rr}	_	39.6	_	nC	T _J = +25°C	
DYNAMIC CHARACTERISTICS (Note 14)							
Input Capacitance	C _{iss}		1021	_	pF	.,	
Output Capacitance			83.1	_	pF	V _{DS} = -30V, V _{GS} = 0V, -f = 1MHz	
Reverse Transfer Capacitance	C _{rss}	_	56.4	_	pF		
Total Gate Charge (Note 15)	Q_g	_	12.1	_	nC	V _{GS} = -5V	
Total Gate Charge (Note 15)	Qg	_	24.2	_	nC	V _{DS} = -30V,	
Gate-Source Charge (Note 15)	Qgs	_	2.5	_	nC	$V_{GS} = -10V$ $I_{D} = -2.9A$	
Gate-Drain Charge (Note 15)	Q _{qd}	_	3.7	_	nC	1	
Turn-On Delay Time (Note 15)	t _{D(on)}	_	3.5	_	ns		
Turn-On Rise Time (Note 15)	tr		4.1	_	ns	V _{DD} = -30V, V _{GS} = -10V,	
Turn-Off Delay Time (Note 15)	t _{D(off)}	_	35	_	ns	$I_D = -1A, R_G \cong 6\Omega$	
Turn-Off Fall Time (Note 15)	t _f		10	_	ns		

Notes:

- 13. Measured under pulsed conditions. Pulse width \leq 300µs; duty cycle \leq 2% 14. For design aid only, not subject to production testing. 15. Switching characteristics are independent of operating junction temperatures.

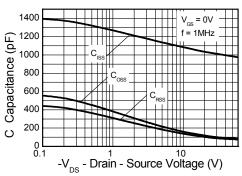


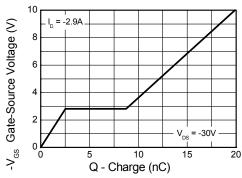
Typical Characteristics





Typical Characteristics (cont.)

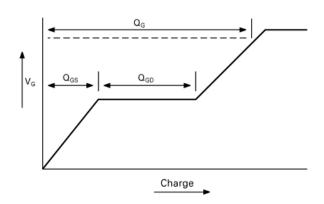


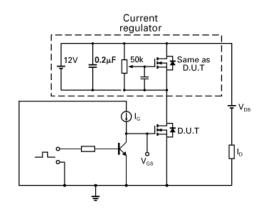


Capacitance v Drain-Source Voltage

Gate-Source Voltage v Gate Charge

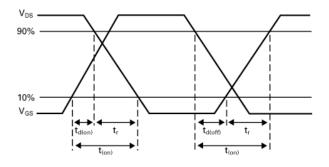
Test Circuits

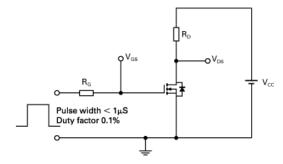




Basic gate charge waveform

Gate charge test circuit





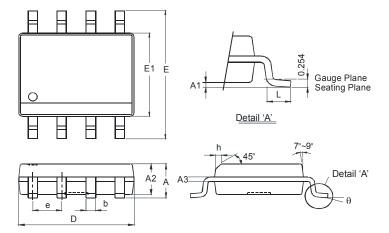
Switching time waveforms

Switching time test circuit



Package Outline Dimensions

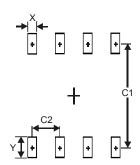
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8					
Dim	Min	Max			
Α		1.75			
A1	0.10	0.20			
A2	1.30	1.50			
A3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
Е	5.90	6.10			
E1	3.85	3.95			
е	1.27 Typ				
h	-	0.35			
L	0.62	0.82			
θ	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
Х	0.60		
Y	1.55		
C1	5.4		
C2	1.27		



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